

Preliminary Technical Information

IXGH30N60B4

Medium-Speed PT Trench IGBT





Symbol	Test Conditions	Maximum R	Maximum Ratings			
V _{CES}	T _{_1} = 25°C to 150°C	600	V			
V _{CGR}	$T_{\rm J}$ = 25°C to 150°C, $R_{\rm GE}$ = 1M Ω	600	V			
V _{GES}	Continuous	±20	V			
V _{GEM}	Transient	±30	V			
I _{C25}	T _c = 25°C	66	A			
I _{C110}	$T_c = 110^{\circ}C$	30	A			
I _{CM}	$T_c = 25^{\circ}C$, 1ms	156	А			
SSOA	$V_{ge} = 15V, T_{vj} = 125^{\circ}C, R_{g} = 10\Omega$	I _{CM} = 48	A			
(RBSOA)	Clamped Inductive Load	$@ \leq V_{CES}$				
P _c	$T_c = 25^{\circ}C$	190	W			
T,		-55 +150	°C			
T _{JM}		150	°C			
T _{stg}		-55 +150	°C			
T	Maximum Lead Temperature for Soldering	300	°C			
	1.6 mm (0.062in.) from Case for 10s	260	°C			
M _d	Mounting Torque	1.13/10	Nm/lb.in.			
Weight		6	g			

Symbol	Test Conditions	Characteristic Values					
$(T_{J} = 25^{\circ}C,$	Unless Otherwise Specified	Min.	Тур.	Max.			
BV _{CES}	$I_{c} = 250\mu A, V_{GE} = 0V$	600			V		
$V_{_{GE(th)}}$	I_{c} = 250 μ A, V_{ce} = V_{ge}	4.0		6.5	V		
I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0V$			10	μA		
	$T_{J} = 125^{\circ}0$	C		500	μA		
I _{GES}	V_{CE} = 0V, V_{GE} = ±20V			±100	nA		
V _{CE(sat)}	$I_{c} = 24A, V_{GE} = 15V, Note 1$		1.5	1.7	V		
. ,	$T_{J} = 125^{\circ}C$	C	1.5		V		





G = Gate C = CollectorE = Emitter Tab = Collector

Features

- Optimized for Low Conduction and Switching Losses
- Square RBSOA
- International Standard Package

Advantages

- High Power Density
- Low Gate Drive Requirement

Applications

- Switch-Mode and Resonant-Mode Power Supplies
- Uninterruptible Power Supplies (UPS)
- DC Choppers
- AC Motor Speed Drives
- DC Servo and Robot Drives
- PFC Circuits

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Symbol Test Conditions			acteristic	Values	TO-247 (IXGH) Outline
$(T_J = 25^{\circ}C \text{ Unless Otherwise Specified})$		Min.	Тур.	Max.	
fs	$I_{c} = 24A, V_{ce} = 10V, Note 1$	10	17	S	
ies)		860	pF	
oes	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$		50	pF	=
res)		29	pF	
)			77	nC	
ge	$I_{c} = 24A, V_{ge} = 15V, V_{ce} = 0.5 \bullet V_{ces}$		9	nC	
gc)		33	nC	
(on))		21	ns	S b b2
	Inductive load, T _J = 25°C		34	ns	
on	$I_{c} = 24A, V_{GE} = 15V$		0.44	m	
off)	$V_{ce} = 400V, R_{g} = 10\Omega$		200	ns	S Dim. Millimeter Inches Min. Max. Min. Ma
	Note 2		88	ns	
off)		0.70	1.30 m.	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$
on)			20	ns	5 b 1.0 1.4 .040 .04 b, 1.65 2.13 .065 .04
	Inductive load, T _J = 125°C		33	ns	b ₂ 2.87 3.12 .113 .12
on	$I_{c} = 24A, V_{GE} = 15V$		0.75	mJ	D 20.80 21.46 .819 .8
off)	$V_{ce} = 400V, R_{g} = 10\Omega$		228	ns	E 15.75 16.26 .610 .64
	Note 2		223 1.50	ns	L 19.81 20.32 .780 .80
off	·		1.50	m	_ <u>L1 4.50 .1</u>
thJC				0.66 °C/W	Q 5.89 6.40 0.232 0.25
thCS			0.21	°C/W	R 4.32 5.49 .170 .21 S 6.15 BSC 242 BSC

Notes:

- 1. Pulse test, t \leq 300µs, duty cycle, d \leq 2%.
- 2. Switching times & energy losses may increase for higher $V_{\rm CE}(clamp),\,T_{\rm J}\, or\,R_{\rm g}.$

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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IXYS MOSFETs and IGBTs are covered	4,835,592	4,931,844	5,049,961	5,237,481	6,162,665	6,404,065 B1	6,683,344	6,727,585	7,005,734 B2	7,157,338B2
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	4,881,106	5,034,796	5,187,117	5,486,715	6,306,728 B1	6,583,505	6,710,463	6,771,478 B2	2 7,071,537	